11/22/2019 505786856

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5833684

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
MASAO KITANO	11/20/2019	

RECEIVING PARTY DATA

Name:	MK BUILD CO., LTD.
Street Address:	5-1-522-103 KOYOCHONAKA, HIGASHINADA-KU
City:	KOBE
State/Country:	JAPAN
Postal Code:	658-0032

PROPERTY NUMBERS Total: 1

Property Type	Number			
Application Number:	16691634			

CORRESPONDENCE DATA

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Correspondent Name: J-PAT U.S. PATENT LEGAL SERVICES

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ATTORNEY DOCKET NUMBER:	032.0005		
NAME OF SUBMITTER:	JAMES W. JUDGE		
SIGNATURE:	/James Judge/		
DATE SIGNED:	11/22/2019		
	This document serves as an Oath/Declaration (37 CFR 1.63).		

Total Attachments: 1

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PATENT REEL: 051094 FRAME: 0858 505786856

J-PAT U.S. PATENT LEGAL SERVICES

j-pat Ref. 032.0005

2019JP06

Assignment-Statement Pursuant to 35 U.S.C. § 115(e) (Combined Assignment and Declaration)

WHEREAS, Masao Kitano, hereinafter referred to as the inventor, as being either a sole inventor or one of joint inventors, has invented certain new and useful improvements in

Deck-Slab Waterproofing-Membrane Application Brush and Deck-Slab Waterproofing-Membrane Application Apparatus Provided Therewith,

for which the inventor has executed an application for United States Patent by his or her signature below, and

WHEREAS, MK Build Co., Ltd., a corporation organized and existing under the laws of Japan, and hereinafter referred to as the assignee, whose mailing address is

6-9 Köyöchönaka, Higashinada-ku, Kobe, Hyogo 658-0032, Japan,

is desirous of acquiring the entire rights in the patent application named above, and insofar as the same yields any United States patent(s), the title to and interest in the same:

Now, therefore, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the inventor assigns, and transfers, unto the assignee, the entire rights in the patent application, and the title to and interest in the same insofar as the same yields any United States patent(s); and the inventor hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all any such patent(s) to the assignee, as that of the entire title to and interest in any such patent(s), for the sole use and behoof of the assignee and the assignee's legal representatives, as fully and entirely as any such patent(s) would have been held by the inventor had the present assignment not been made.

Statements Required by 35 U.S.C. § 115(b) and (c)

As the above named inventor, I hereby declare that:

上記発明者である私は、次のことがらを宣誓します。

The above-identified application was made or authorized to be made by me.

上記の出願は私自身、あるいは私が権限を接与したものによって行われたものです。

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

私は本出願書中にあらわれるもともとの発明者、あるいはもともとの共同発明者です。

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

本宣響書において故意に虚偽の申し立てを行った場合は18 U.S.C. 1001 により、罰金あるいは 最高五(5)年の禁锢刑、あるいはその両方による罰則の対象となることを認めます。

in testimony whereof the inventor has below executed this assignment-cum-declaration.

Legal Name 発明者の正			tano		Date 日付	11/20	12019
Signature 署名	ユセ	¥}	C.	/ ^R			

PATENT REEL: 051094 FRAME: 0859

^{*} Declaration for patent application using an Application Data Sheet.